APPLICA	BLE STAN	IDARD										
OPERATING		RE RANGE				DRAGE MPERATURE RANGE -10°C		-10°C TO + 60°C	TO + 60°C (NOTE3)			
RATING	TEMPERATURE RANGE OPERATING HUMIDITY RANGE		STOI		STOR	ORAGE MIDITY RANGE			40 % TO 70 % (NOTE			
		.,0_			APPL	ICABLE		+				
	VOLTAGE		AC/DC 100V AWG 28 : 1.0			CONNECTOR APPLICABLE		+	DF50-*DS-1 DF50-2830SC			
CURRENT			AWG 20 : 1.0			TACT	_		טו טט−∠סטט∂ט	Λ.		
			AWG 32 : 0.7									
	ı			CIFICA	ATIO	NS						
	 ГЕМ		TEST METHOD				R	EQL	JIREMENTS	Тат	TA	
CONSTR	RUCTION	· ·			I					-		
SENERAL EX	AMINATION	VISUALLY AND BY MEASURING INSTRUMENT.				ACCORDING TO DRAWING.				X		
MARKING		CONFIRMED VISUALLY.				1				Х	>	
	IC CHARA											
CONTACT	RESISTANCE	AC 20mV	MAX 1mA (DC OR 1000 I	Hz).	[3	80mΩ M	IAX.			X	-	
NSULATION RESISTANC		100V DC.			5	0 0 ΜΩ	MIN.			X	-	
OLTAGE P		300V AC	300V AC FOR 1 min.			IO FLA	SHOVER	OR	BREAKDOWN.	X	†-	
/IECHAN	VICAL CH	ARACTE	ERISTICS									
MECHANICA DPERATION		30TIMES INSERTIONS AND EXTRACTIONS.				① CONTACT RESISTANCE: 50mΩ MAX.				\ ,,		
/IBRATION		ERECUE	EDECUENCY 40 TO 55 H- ONIOLE AMPLITUDE			② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				\perp^{x}	_	
אטואאטוו					2 NO			DISCONTINUITY OF 1µs. RACK OR LOOSENESS	×	-		
HOCK		490 m/s ²	490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.			UF	FAKIS.					
NVIRO	NMENTAI		ACTERISTICS									
DAMP HEAT (STEADY STATE)		EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.				 CONTACT RESISTANCE: 50mΩ MAX. INSULATION RESISTANCE: 100MΩ MIN. NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 				-		
RAPID CHANGE OF TEMPERATURE		TEMPERATURE -55→+85°C TIME 30→ 30min. UNDER 5 CYCLES. THE TRANSFERRING TIME OF THE TANK IS 2~3 min.			① CONTACT RESISTANCE: 50mΩ MAX.				X	-		
COUN	COUNT DESCRIPTION OF REVISIONS		ON OF REVISIONS	DESIGNI			INED		CHECKED		DATE	
·——·							APPROV	/ED	KI. AKIYAMA	10.	06. (
							CHECK	ED	OM. MIYAMOTO	10.	06.0	
							DESIGNED		TT. OHSAKO			
							DRAW		TT. OHSAKO	_	06. (
Note QT:Qualification Test AT:Assurance Test X:Applicable Test			est	DRAWING NO.				ELC4-332213-01				
HS.			CATION SHEET		PART NO.			DF50-*DP-1H(51)				
.					CODE NO.		CI 665_		CL665-	0	1/2	
	1				OODE	110.			02000	J	_''^	

SPECIFICATIONS								
ITEM	TEST METHOD	REQUIREMENTS	QT	АТ				
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE, 245°C FOR INSERTION DURATION, 5 sec.	SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.	Х	_				
RESISTANCE TO SOLDERING HEAT	1) REFLOW SOLDERING «REFLOW AREA» MAX250°C WITHIN 10 sec MIN 220°C WITHIN 60 sec «PREHEATING AREA» 150~180°C 90~120s 2) MANUAL SOLDERING SOLDERING IPON TEMPERRATURE 350±10°C SOLDERING TIME 3~4s. NO STRENGTH ON CONTACT.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	X	_				

REMARKS

NOTE 1: INCLUDING THE TEMPERATURE RISE BY CURRENT.

NOTE 2: NON-CONDENSING

NOTE 3: APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE PCB ON BOARD.

AFTER PCB BOARD, OPERATING TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERIM STORAGE DURING TRANSPORTATION

Unless otherwise specifid, refer to JIS C 5402.

Note QT:0	Qualification Test AT:Assurance Test X:Applicable Test	DRAWIN	NG NO.	ELC4-332213-01		
HRS	SPECIFICATION SHEET	PART NO. DF50-*DP-1H(51)	
	HIROSE ELECTRIC CO., LTD.	CODE NO		CL665-	A	2/2